

# Octal Buffer/Line Driver with 3-State Outputs

## 74AC240, 74ACT240

### General Description

The AC240/ACT240 is an octal buffer and line driver designed to be employed as memory and address driver, clock drivers and bus oriented transmitter or receiver which provides improved PC board density.

### Features

- $I_{CC}$  and  $I_{OZ}$  Reduced by 50%
- Inverting 3-State Outputs drive Bus Lines or Buffer Memory Address Registers
- Outputs Source/Sink 24 mA
- ACT240 has TTL-compatible Inputs
- These are Pb-Free Devices

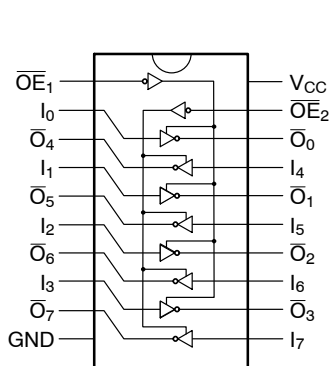


Figure 1. Connection Diagram

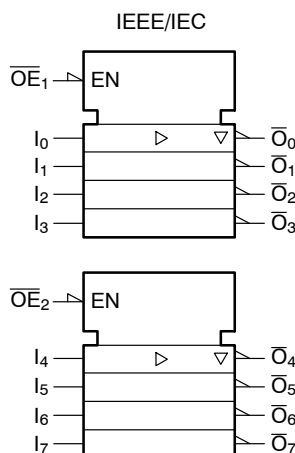


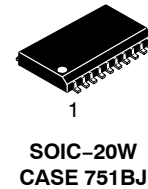
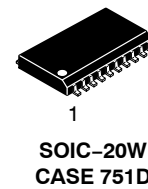
Figure 2. Logic Symbol

### TRUTH TABLES

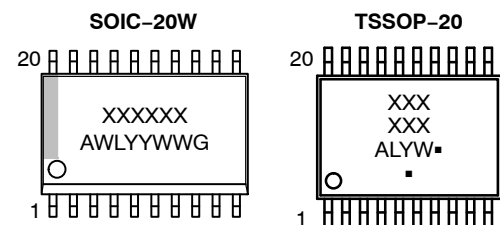
Inputs		Outputs (Pins 12, 14, 16, 18)
$\overline{OE}_1$	$I_n$	
L	L	H
L	H	L
H	X	Z

Inputs		Outputs (Pins 3, 5, 7, 9)
$\overline{OE}_2$	$I_n$	
L	L	H
L	H	L
H	X	Z

NOTE: H = HIGH Voltage Level  
L = LOW Voltage Level  
X = Immaterial  
Z = High Impedance



### MARKING DIAGRAMS



XXX = Specific Device Code  
A = Assembly Location  
WL, L = Wafer Lot  
YY, Y = Year  
WW, W = Work Week  
G or ■ = Pb-Free Package  
(Note: Microdot may be in either location)

### ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

### PIN DESCRIPTION

Pin Names	Description
$\overline{OE}_1, \overline{OE}_2$	3-State Output Enable Inputs
$I_0$ - $I_7$	Inputs
$\overline{O}_0$ - $\overline{O}_7$	Outputs

## 74AC240, 74ACT240

### ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Rating	Unit
$V_{CC}$	Supply Voltage	-0.5 to +6.5	V
$I_{IK}$	DC Input Diode Current $V_I = -0.5\text{ V}$ $V_I = V_{CC} + 0.5\text{ V}$	-20 +20	mA
$V_I$	DC Input Voltage	-0.5 to $V_{CC} + 0.5$	V
$I_{OK}$	DC Output Diode Current $V_O = -0.5\text{ V}$ $V_O = V_{CC} + 0.5\text{ V}$	-20 +20	mA
$V_O$	DC Output Voltage	-0.5 to $V_{CC} + 0.5$	V
$I_O$	DC Output Source or Sink Current	$\pm 50$	mA
$I_{CC}$ or $I_{GND}$	DC $V_{CC}$ or Ground Current per Output Pin	$\pm 50$	mA
$T_{STG}$	Storage Temperature	-65 to +150	$^{\circ}\text{C}$
$T_J$	Junction Temperature	140	$^{\circ}\text{C}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

### RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
$V_{CC}$	Supply Voltage AC ACT	2.0 4.5	6.0 5.5	V
$V_I$	Input Voltage	0	$V_{CC}$	V
$V_O$	Output Voltage	0	$V_{CC}$	V
$T_A$	Operating Temperature	-40	85	$^{\circ}\text{C}$
$\Delta V/\Delta t$	Minimum Input Edge Rate, AC Devices: $V_{IN}$ from 30% to 70% $V_{CC}$ , $V_{CC}$ @ 3.3 V, 4.5 V, 5.5 V	125		mV/ns
$\Delta V/\Delta t$	Minimum Input Edge Rate, ACT Devices: $V_{IN}$ from 0.8 V to 2.0 V, $V_{CC}$ @ 4.5 V, 5.5 V	125		mV/ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

## 74AC240, 74ACT240

### DC ELECTRICAL CHARACTERISTICS FOR AC

Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	T <sub>A</sub> = +25°C		T <sub>A</sub> = -40°C to +85°C		Unit
				Typ	Guaranteed Limits			
V <sub>IH</sub>	Minimum HIGH Level Input Voltage	3.0	V <sub>OUT</sub> = 0.1 V or V <sub>CC</sub> - 0.1 V	1.5	2.1	2.1		V
		4.5		2.25	3.15	3.15		
		5.5		2.75	3.85	3.85		
V <sub>IL</sub>	Maximum LOW Level Input Voltage	3.0	V <sub>OUT</sub> = 0.1 V or V <sub>CC</sub> - 0.1 V	1.5	0.9	0.9		V
		4.5		2.25	1.35	1.35		
		5.5		2.75	1.65	1.65		
V <sub>OH</sub>	Minimum HIGH Level Output Voltage	3.0	I <sub>OUT</sub> = -50 μA	2.99	2.9	2.9		V
		4.5		4.49	4.4	4.4		
		5.5		5.49	5.4	5.4		
		3.0	V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> , I <sub>OH</sub> = -12 mA		2.56	2.46		
		4.5		3.86	3.76			
		5.5		4.86	4.76			
V <sub>OL</sub>	Maximum LOW Level Output Voltage	3.0	I <sub>OUT</sub> = 50 μA	0.002	0.1	0.1		V
		4.5		0.001	0.1	0.1		
		5.5		0.001	0.1	0.1		
		3.0	V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> , I <sub>OL</sub> = 12 mA		0.36	0.44		
		4.5		0.36	0.44			
		5.5		0.36	0.44			
I <sub>IN</sub> (Note 2)	Maximum Input Leakage Current	5.5	V <sub>I</sub> = V <sub>CC</sub> , GND		±0.1	±1.0		μA
I <sub>OZ</sub>	Maximum 3-STATE Leakage Current	5.5	V <sub>I</sub> (OE) = V <sub>IL</sub> , V <sub>IH</sub> ; V <sub>I</sub> = V <sub>CC</sub> , GND; V <sub>O</sub> = V <sub>CC</sub> , GND		±0.25	±2.5		μA
I <sub>OLD</sub>	Minimum Dynamic Output Current (Note 3)	5.5	V <sub>OLD</sub> = 1.65 V Max.			75		mA
I <sub>OHD</sub>		5.5	V <sub>OHD</sub> = 3.85 V Min.			-75		mA
I <sub>CC</sub> (Note 2)	Maximum Quiescent Supply Current	5.5	V <sub>IN</sub> = V <sub>CC</sub> or GND		4.0	40.0		μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. All outputs loaded; thresholds on input associated with output under test.
2. I<sub>IN</sub> and I<sub>CC</sub> @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V<sub>CC</sub>.
3. Maximum test duration 2.0 ms, one output loaded at a time.

## 74AC240, 74ACT240

### DC ELECTRICAL CHARACTERISTICS FOR ACT

Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	T <sub>A</sub> = +25°C		T <sub>A</sub> = -40°C to +85°C		Unit
				Typ	Guaranteed Limits			
V <sub>IH</sub>	Minimum HIGH Level Input Voltage	4.5	V <sub>OUT</sub> = 0.1 V or V <sub>CC</sub> - 0.1 V	1.5	2.0	2.0		V
		5.5		1.5	2.0	2.0		
V <sub>IL</sub>	Maximum LOW Level Input Voltage	4.5	V <sub>OUT</sub> = 0.1 V or V <sub>CC</sub> - 0.1 V	1.5	0.8	0.8		V
		5.5		1.5	0.8	0.8		
V <sub>OH</sub>	Minimum HIGH Level Output Voltage	4.5	I <sub>OUT</sub> = -50 μA	4.49	4.4	4.4		V
		5.5		5.49	5.4	5.4		
		4.5	V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> , I <sub>OH</sub> = -24 mA		3.86	3.76		
		5.5		V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> , I <sub>OH</sub> = -24 mA (Note 4)		4.86	4.76	
V <sub>OL</sub>	Maximum LOW Level Output Voltage	4.5	I <sub>OUT</sub> = 50 μA	0.001	0.1	0.1		V
		5.5		0.001	0.1	0.1		
		4.5	V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> , I <sub>OL</sub> = 24 mA		0.36	0.44		
		5.5		V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> , I <sub>OL</sub> = 24 mA (Note 4)		0.36	0.44	
I <sub>IN</sub>	Maximum Input Leakage Current	5.5	V <sub>I</sub> = V <sub>CC</sub> , GND		±0.1	±1.0		μA
I <sub>OZ</sub>	Maximum 3-STATE Leakage Current	5.5	V <sub>I</sub> = V <sub>IL</sub> , V <sub>IH</sub> , V <sub>O</sub> = V <sub>CC</sub> , GND		±0.25	±2.5		μA
I <sub>CCT</sub>	Maximum I <sub>CC</sub> /Input	5.5	V <sub>I</sub> = V <sub>CC</sub> - 2.1 V	0.6		1.5		mA
I <sub>OLD</sub>	Minimum Dynamic Output Current (Note 5)	5.5	V <sub>OLD</sub> = 1.65 V Max.			75		mA
I <sub>OHD</sub>		5.5	V <sub>OHD</sub> = 3.85 V Min.			-75		mA
I <sub>CC</sub>	Maximum Quiescent Supply Current	5.5	V <sub>IN</sub> = V <sub>CC</sub> or GND		4.0	40.0		μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. All outputs loaded; thresholds on input associated with output under test.
5. Maximum test duration 2.0 ms, one output loaded at a time.

## 74AC240, 74ACT240

### AC ELECTRICAL CHARACTERISTICS FOR AC

Symbol	Parameter	V <sub>CC</sub> (V) (Note 6)	T <sub>A</sub> = +25°C, C <sub>L</sub> = 50 pF			T <sub>A</sub> = -40°C to +85°C, C <sub>L</sub> = 50 pF		Unit
			Min	Typ	Max	Min	Max	
t <sub>PLH</sub>	Propagation Delay, Data to Output	3.3	1.5	6.0	8.0	1.0	9.0	ns
		5.0	1.5	4.5	6.5	1.0	7.0	
t <sub>PHL</sub>	Propagation Delay, Data to Output	3.3	1.5	5.5	8.0	1.0	8.5	ns
		5.0	1.5	4.5	6.0	1.0	6.5	
t <sub>PZH</sub>	Output Enable Time	3.3	1.5	6.0	10.5	1.0	11.0	ns
		5.0	1.5	5.0	7.0	1.0	8.0	
t <sub>PZL</sub>	Output Enable Time	3.3	1.5	7.0	10.0	1.0	11.0	ns
		5.0	1.5	5.5	8.0	1.0	8.5	
t <sub>PHZ</sub>	Output Disable Time	3.3	1.5	7.0	10.0	1.0	10.5	ns
		5.0	1.5	6.5	9.0	1.0	9.5	
t <sub>PLZ</sub>	Output Disable Time	3.3	1.5	7.5	10.5	1.0	11.5	ns
		5.0	1.5	6.5	9.0	1.0	9.5	

6. Voltage range 3.3 is 3.3 V ± 0.3 V. Voltage range 5.0 is 5.0 V ± 0.5 V.

### AC ELECTRICAL CHARACTERISTICS FOR ACT

Symbol	Parameter	V <sub>CC</sub> (V) (Note 7)	T <sub>A</sub> = +25°C, C <sub>L</sub> = 50 pF			T <sub>A</sub> = -40°C to +85°C, C <sub>L</sub> = 50 pF		Unit
			Min	Typ	Max	Min	Max	
t <sub>PLH</sub>	Propagation Delay, Data to Output	5.0	1.5	6.0	8.5	1.5	9.5	ns
t <sub>PHL</sub>	Propagation Delay, Data to Output	5.0	1.5	5.5	7.5	1.5	8.5	ns
t <sub>PZH</sub>	Output Enable Time	5.0	1.5	7.0	8.5	1.0	9.5	ns
t <sub>PZL</sub>	Output Enable Time	5.0	2.0	7.0	9.5	1.5	10.5	ns
t <sub>PHZ</sub>	Output Disable Time	5.0	2.0	8.0	9.5	2.0	10.5	ns
t <sub>PLZ</sub>	Output Disable Time	5.0	2.5	6.5	10.0	2.0	10.5	ns

7. Voltage range 5.0 is 5.0 V ± 0.5 V.

### CAPACITANCE

Symbol	Parameter	Conditions	Typ	Unit
C <sub>IN</sub>	Input Capacitance	V <sub>CC</sub> = OPEN	4.5	pF
C <sub>PD</sub>	Power Dissipation Capacitance	V <sub>CC</sub> = 5.0 V	45.0	pF

## 74AC240, 74ACT240

### ORDERING INFORMATION

Device	Device Marking	Package	Shipping <sup>†</sup>
74AC240SCX	AC240	SOIC-20W, case 751BJ (Pb-Free)	1000 / Tape & Reel
74ACT240SCX	ACT240	SOIC-20W, case 751BJ (Pb-Free)	1000 / Tape & Reel
74ACT240MTC	ACT 240	TSSOP-20, case 948E (Pb-Free)	75 Units / Tube
74ACT240MTCX	ACT 240	TSSOP-20, case 948AQ (Pb-Free)	2500 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NOTE: All packages are Pb-Free per JEDEC: J-STD-020B standard.

# MECHANICAL CASE OUTLINE

## PACKAGE DIMENSIONS

ON Semiconductor®



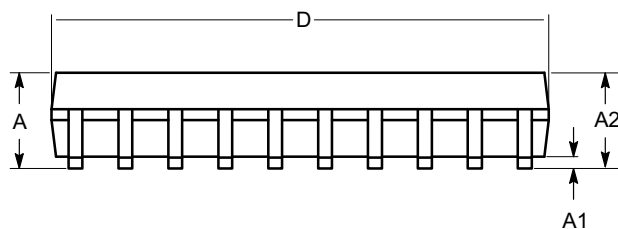
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CASE 751BJ-01  
ISSUE O

DATE 19 DEC 2008

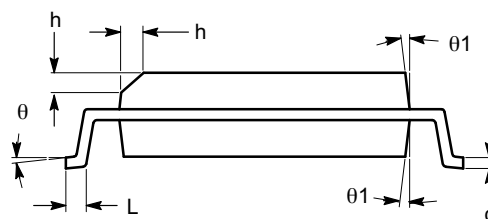


TOP VIEW

SYMBOL	MIN	NOM	MAX
A	2.36	2.49	2.64
A1	0.10		0.30
A2	2.05		2.55
b	0.31	0.41	0.51
c	0.20	0.27	0.33
D	12.60	12.80	13.00
E	10.01	10.30	10.64
E1	7.40	7.50	7.60
e	1.27 BSC		
h	0.25		0.75
L	0.40	0.81	1.27
$\theta$	0°		8°
$\theta 1$	5°		15°



SIDE VIEW



END VIEW

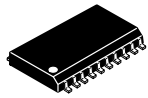
**Notes:**

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MS-013.

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# MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



SCALE 1:1

SOIC-20 WB  
CASE 751D-05  
ISSUE H

DATE 22 APR 2015



NOTES:

1. DIMENSIONS ARE IN MILLIMETERS.
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS	
	MIN	MAX
A	2.35	2.65
A1	0.10	0.25
b	0.35	0.49
c	0.23	0.32
D	12.65	12.95
E	7.40	7.60
e	1.27 BSC	
H	10.05	10.55
h	0.25	0.75
L	0.50	0.90
θ	0°	7°

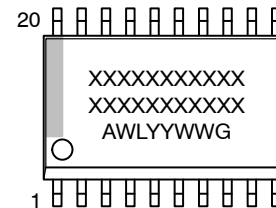
RECOMMENDED  
SOLDERING FOOTPRINT\*



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC  
MARKING DIAGRAM\*



- XXXXXX = Specific Device Code
- A = Assembly Location
- WL = Wafer Lot
- YY = Year
- WW = Work Week
- G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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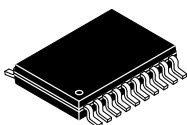
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# MECHANICAL CASE OUTLINE

## PACKAGE DIMENSIONS

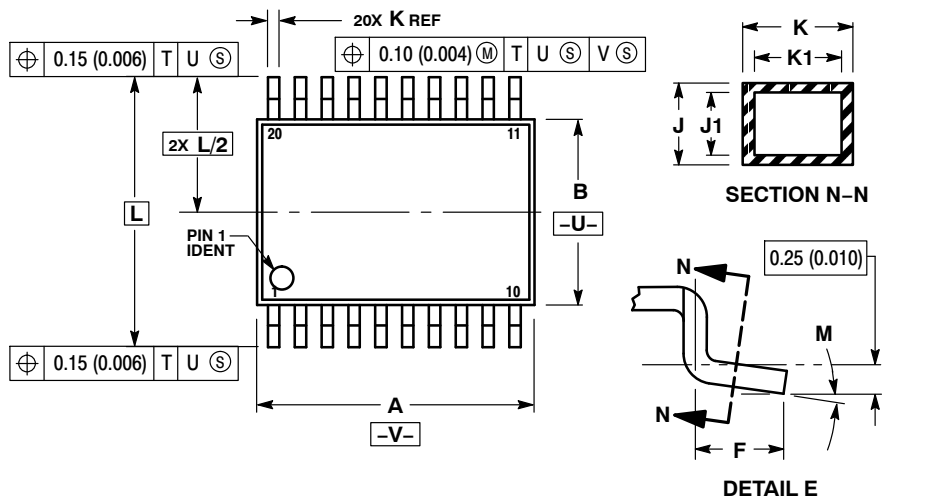
ON Semiconductor®



**TSSOP-20 WB**  
CASE 948E  
ISSUE D

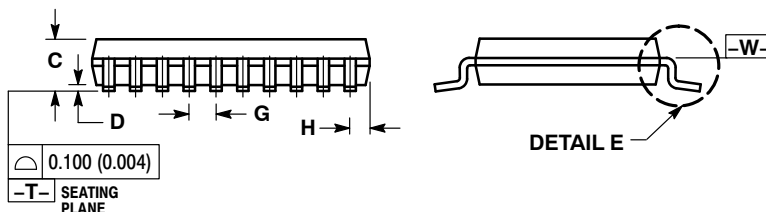
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SCALE 2:1

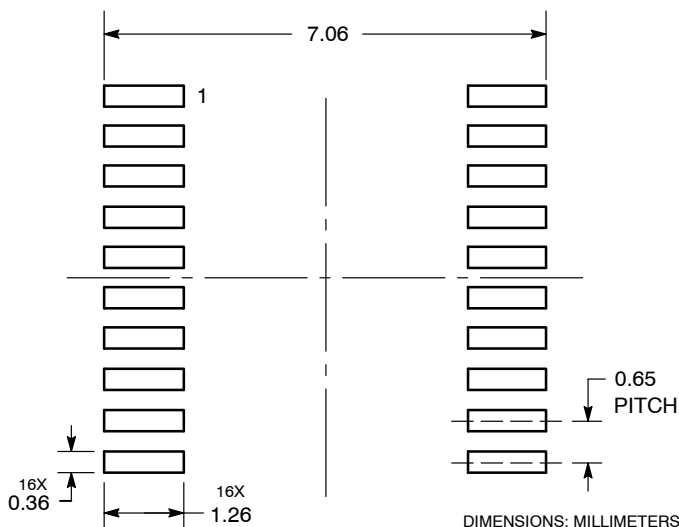


- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
  5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
  6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
  7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

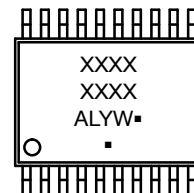
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	6.40	6.60	0.252	0.260
B	4.30	4.50	0.169	0.177
C	---	1.20	---	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.27	0.37	0.011	0.015
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°



### SOLDERING FOOTPRINT



### GENERIC MARKING DIAGRAM\*



- A = Assembly Location
- L = Wafer Lot
- Y = Year
- W = Work Week
- = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

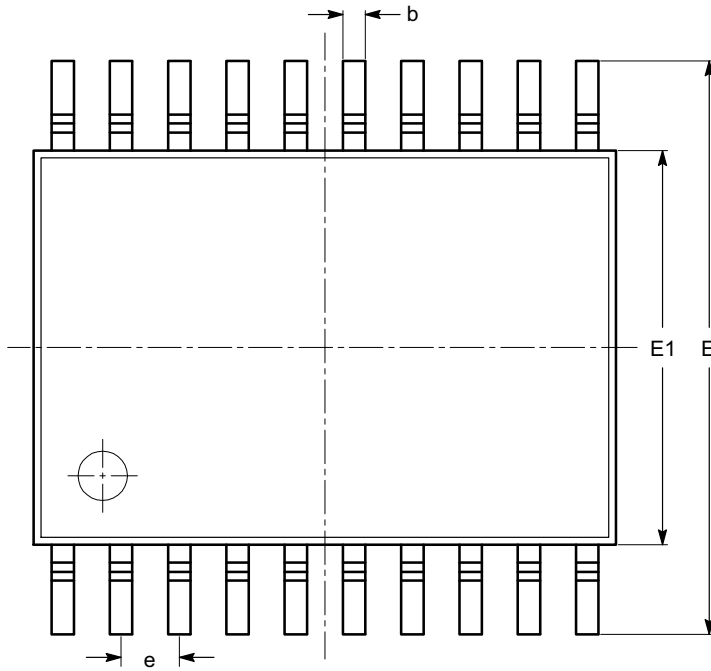
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**MECHANICAL CASE OUTLINE**  
**PACKAGE DIMENSIONS**

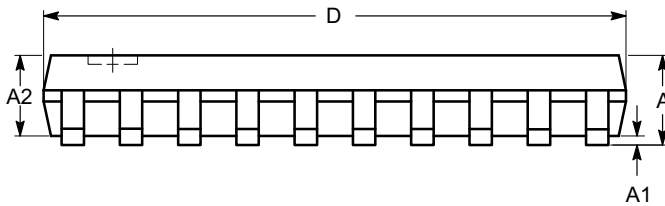
TSSOP20, 4.4x6.5  
CASE 948AQ-01  
ISSUE A

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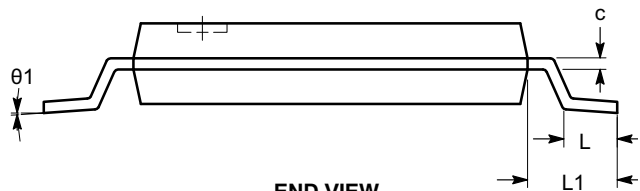


SYMBOL	MIN	NOM	MAX
A			1.20
A1	0.05		0.15
A2	0.80		1.05
b	0.19		0.30
c	0.09		0.20
D	6.40	6.50	6.60
E	6.30	6.40	6.50
E1	4.30	4.40	4.50
e	0.65 BSC		
L	0.45	0.60	0.75
L1	1.00 REF		
$\theta$	0°		8°

TOP VIEW



SIDE VIEW



END VIEW

**Notes:**

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MO-153.

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